Standard specifications of 25x25mm² MBE β-Ga₂O₃ epitaxial wafers

Epitaxial layer (Growth method: MBE)

Property	Specification	
Dopant	Si (n-type)	Undoped (semi-insulating)
Doping concentration	Specify a value in the range between 1x10 ¹⁷ and 2x10 ¹⁸ cm ⁻³	-
Thickness	Specify a value in the range between 0.1 and 0.5 µm	
Wafers		
Property	Specification	
Dopant	Fe (semi-insulating)	
Doping concentration	-	
Resistivity	$>10^{10}\Omega cm$	
Orientation	(010)	

0.5 mm

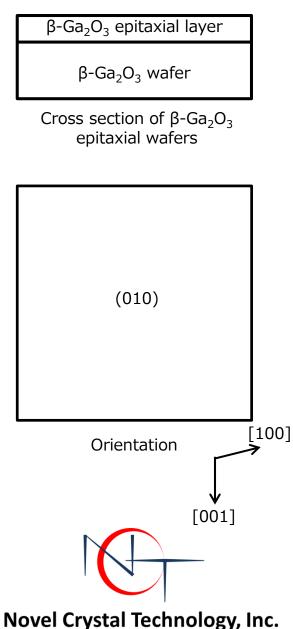
≤350 arcsec

 $0^{\circ}\pm1^{\circ}$

Off	set	angl	le
D	1		

Thickness

XRD FWHM



¹ These products must be used for research and development purposes only.

² The substrates must not be used as a seed crystal.

³ The specifications are subject to change without notice.

Standard specifications of 10x15mm² MBE β-Ga₂O₃ epitaxial wafers

Epitaxial layer (Growth method: MBE)

Property	Specification	
Dopant	Si (n-type)	Undoped (semi-insulating)
Doping concentration	Specify a value in the range between 1x10 ¹⁷ and 2x10 ¹⁸ cm ⁻³	-
Thickness	Specify a value in the range between 0.1 and 0.5 µm	

β-Ga ₂ O ₃ epitaxial layer	
β-Ga ₂ O ₃ wafer	

Cross section of β-Ga₂O₃ epitaxial wafers

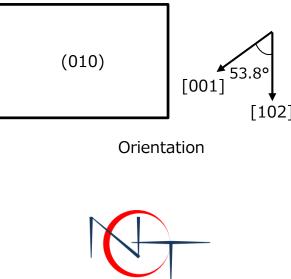
Wafers

Property	Specification	
Dopant	Sn (n-type)	Fe (semi-insulating)
Doping concentration	1-9x10 ¹⁸ cm ⁻³	-
Resistivity	-	$>10^{10}\Omega cm$
Orientation	(010)	
Size	10x15 mm ²	
Thickness	0.5 mm	
XRD FWHM	≦150 arcsec	
Off set angle	0°±1°	

Remarks

1 These products must be used for research and development purposes only.

- 2 The substrates must not be used as a seed crystal.
- 3 The specifications are subject to change without notice.



Novel Crystal Technology, Inc.